



INTERNATIONAL
GEMOLOGICAL
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

July 8, 2025

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

Cut Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

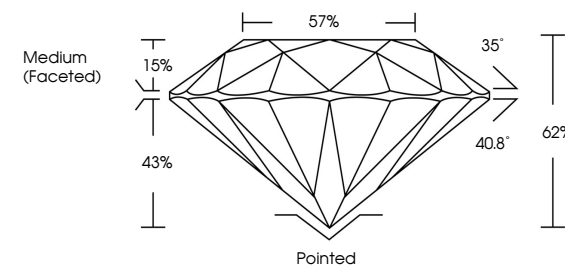
Inscription(s)

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

LG720589020

Report verification at igi.org

PROPORTIONS



Medium (Faceted)

57%

35°

40.8°

62%

Pointed



Sample Image Used

COLOR

D

E

F

G

H

I

J

Faint

Very Light

Light

CLARITY

IF

VS¹⁻²

VS¹⁻²

SI¹⁻²

I¹⁻³

Internally Flawless

Very Very Slightly Included

Very Slightly Included

Slightly Included

Included



IGI

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IGI Report No LG720589020

ROUND BRILLIANT

6.76 - 6.79 X 4.20 MM

Carat Weight

Color Grade

Clarity Grade

Cut Grade

Depth

Table

Girdle

Medium (Faceted)

Pointed

EXCELLENT

EXCELLENT

NONE

IGI LG720589020

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Type II

1.19 CARAT

D

VVS 1

IDEAL

62%

57%

Culet

Polish

Symmetry

Fluorescence

Inscriptions(s)

IGI



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